



THE DATASHEET OF G3VM-401D



G3VM-401A/D

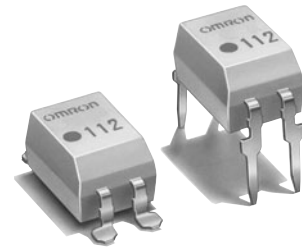
MOS FET Relays

Expanded Range of Analog-switching MOS FET Relays with 400-V Load Voltage.



- Continuous load current of 120 mA.
- Dielectric strength of 2,500 Vrms between I/O.

RoHS compliant

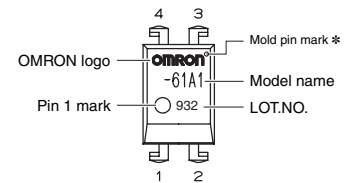
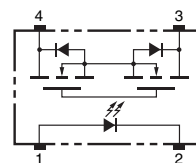


Note: The actual product is marked differently from the image shown here.

Application Examples

- Test & Measurement equipment
- Security equipment
- Amusement equipment

Terminal Arrangement/Internal Connections



Note: The actual product is marked differently from the image shown here.
* The indentation in the corner diagonally opposite from the pin 1 mark is from a pin on the mold.

List of Models

Package type	Contact form	Terminals	Load voltage (peak value) *	Model	Minimum package quantity	
					Number per tube	Number per tape and reel
DIP4	1a (SPST-NO)	PCB Terminals	400 V	G3VM-401A	100	-
		Surface-mounting Terminals		G3VM-401D		
				G3VM-401D (TR)	-	1,500

* The AC peak and DC value are given for the load voltage.

Absolute Maximum Ratings (Ta = 25°C)

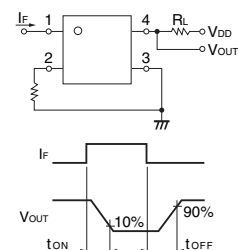
Item	Symbol	Rating	Unit	Measurement conditions	
Input	LED forward current	IF	50	mA	
	Repetitive peak LED forward current	IFP	1	A	
	LED forward current reduction rate	$\Delta I_F / ^\circ C$	-0.5	mA/°C	100 μ s pulses, 100 pps Ta \geq 25°C
	LED reverse voltage	VR	5	V	
Connection temperature		TJ	125	°C	
Output	Load voltage (AC peak/DC)	V _{OFF}	400	V	
	Continuous load current (AC peak/DC)	Io	120	mA	
	ON current reduction rate	$\Delta I_o / ^\circ C$	-1.2	mA/°C	Ta \geq 25°C
	Connection temperature		TJ	125	°C
Dielectric strength between I/O (See note 1.)		V _{I-O}	2500	Vrms	AC for 1 min
Ambient operating temperature		Ta	-40 to +85	°C	With no icing or condensation
Ambient storage temperature		Tstg	-55 to +125	°C	With no icing or condensation
Soldering temperature		-	260	°C	10 s

Note: 1. The dielectric strength between the input and output was checked by applying voltage between all pins as a group on the LED side and all pins as a group on the light-receiving side.

Electrical Characteristics (Ta = 25°C)

Item	Symbol	Minimum	Typical	Maximum	Unit	Measurement conditions	
Input	LED forward voltage	V _F	1.0	1.15	1.3	V	IF = 10 mA
	Reverse current	IR	-	-	10	μ A	VR = 5 V
	Capacity between terminals	CT	-	30	-	pF	V = 0, f = 1 MHz
	Trigger LED forward current	IFT	-	1	3	mA	Io = 120 mA
Output	Maximum resistance with output ON	RON	-	18	35	Ω	IF = 5 mA, Io = 120 mA
	Current leakage when the relay is open	I _{LEAK}	-	-	1.0	μ A	V _{OFF} = 400 V
	Capacity between terminals	C _{OFF}	-	40	-	pF	V = 0, f = 1 MHz
	Capacity between I/O terminals	C _{I-O}	-	0.8	-	pF	f = 1 MHz, Vs = 0 V
	Insulation resistance between I/O terminals	R _{I-O}	1000	-	-	M Ω	V _{I-O} = 500 VDC, RoH \leq 60%
Turn-ON time	t _{ON}	-	-	1.0	ms	IF = 5 mA, RL = 200 Ω , VDD = 20 V(See note 2.)	
Turn-OFF time	t _{OFF}	-	-	1.0	ms		

Note: 2. Turn-ON and Turn-OFF Times



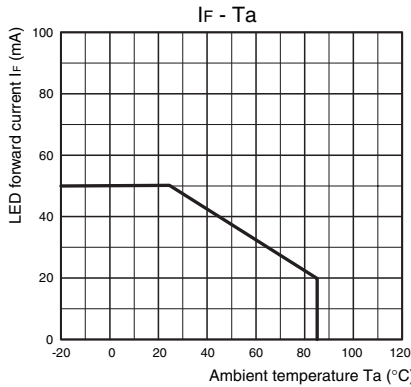
Recommended Operating Conditions

Use the G3VM under the following conditions so that the Relay will operate properly.

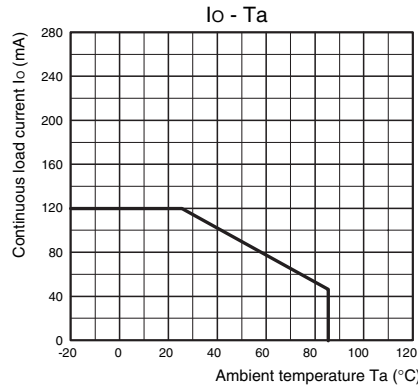
Item	Symbol	Minimum	Typical	Maximum	Unit
Load voltage (AC peak/DC)	V _{DD}	-	-	320	V
Operating LED forward current	I _F	5	7.5	25	mA
Continuous load current (AC peak/DC)	I _O	-	-	100	mA
Ambient operating temperature	T _a	-20	-	65	°C

Engineering Data

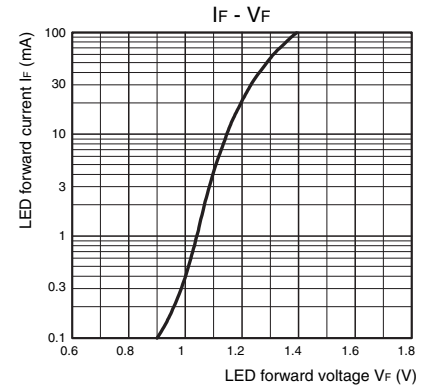
LED forward current vs. Ambient temperature



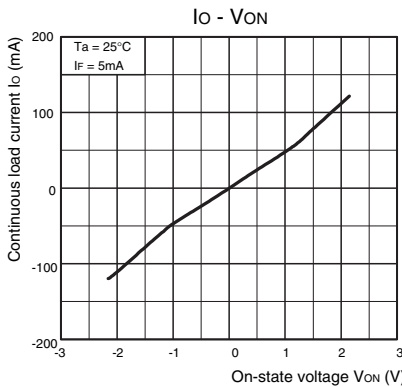
Continuous load current vs. Ambient temperature



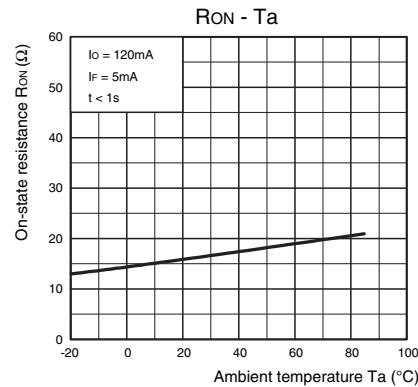
LED forward current vs. LED forward voltage



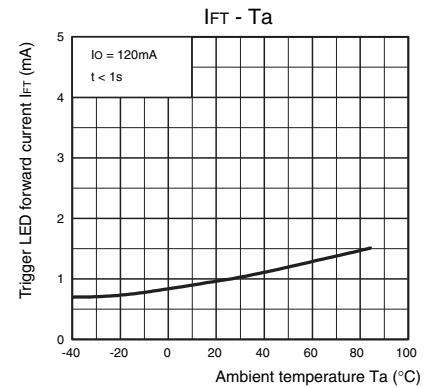
Continuous load current vs. On-state voltage



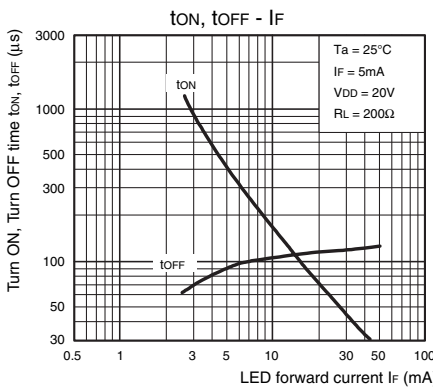
On-state resistance vs. Ambient temperature



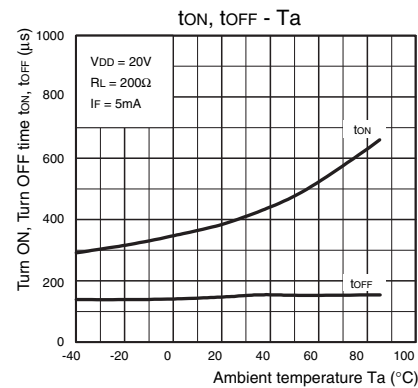
Trigger LED forward current vs. Ambient temperature



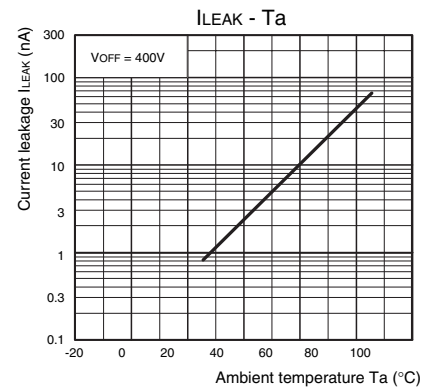
Turn ON, Turn OFF time vs. LED forward current



Turn ON, Turn OFF time vs. Ambient temperature



Current leakage vs. Ambient temperature



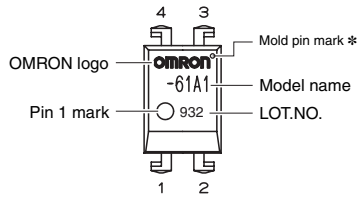
Safety Precautions

- Refer to "Common Precautions" for all G3VM models.

■ Appearance

DIP (Dual Inline Package)

DIP4

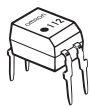


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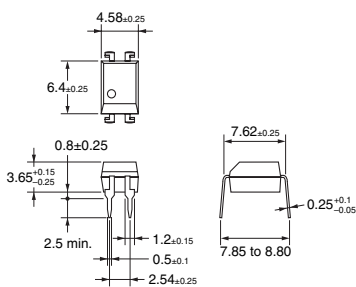
■ Dimensions

(Unit:mm)



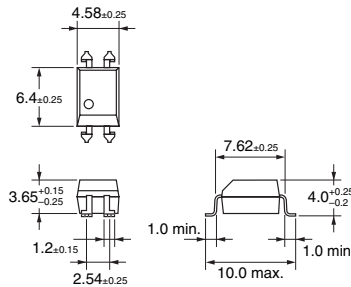
PCB Terminals

Weight: 0.25 g

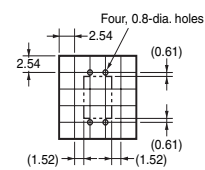


Surface-mounting Terminals

Weight: 0.25 g

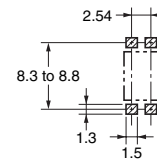


PCB Dimensions (BOTTOM VIEW)



Actual Mounting Pad Dimensions

(Recommended Value, TOP VIEW)



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- Application examples provided in this document are for reference only. In actual applications, confirm equipment functions and safety before using the product.
- Consult your OMRON representative before using the product under conditions which are not described in the manual or applying the product to nuclear control systems, railroad systems, aviation systems, vehicles, combustion systems, medical equipment, amusement machines, safety equipment, and other systems or equipment that may have a serious influence on lives and property if used improperly. Make sure that the ratings and performance characteristics of the product provide a margin of safety for the system or equipment, and be sure to provide the system or equipment with double safety mechanisms.

Note: Do not use this document to operate the Unit.

OMRON Corporation

ELECTRONIC AND MECHANICAL COMPONENTS COMPANY

Contact: www.omron.com/ecb

Cat. No. **K149-E1-01**
0412(0412)(O)

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